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Atty. Docket No. CPAC 1017-2  
Appl. No. 10/632,549

NOV 29 2005

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Marcos KARNEZOS

Application No.: 10/632,549

Filed: August 2, 2003

Title: **Semiconductor multi-package module  
having wire bond interconnect between  
stacked packages**

) Examiner: Phat X. CAO

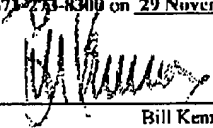
) Group Art Unit: 2814

) Date: 29 November, 2005.

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Fax no. 571-273-8300 on 29 November 2005.

Signed

  
Bill Kennedy

MAIL STOP RCE  
COMMISSIONER FOR PATENTS  
P.O. Box 1450  
ALEXANDRIA, VA 22313-1450

**AMENDMENT  
ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION**

Dear Sir:

Applicant responds as follows to the Final Office action mailed June 29, 2005.

**Amendments to the Specification** begin on page 2 of this paper.

Amendments to the claims are reflected in the **Listing of Claims** which begins on page 3 of this paper.

**Remarks** begin on page 6 of this paper.